

101282C

ID36-2.5-9U-36 MHz Dispersive Delay Line 2.5 MHz Bandwidth

Specifications

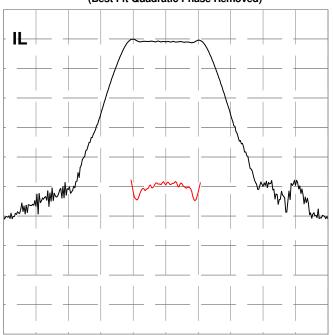
| Parameter | Symbol | Min | Typical | Max | Unit |
|-----------------------------------|----------------|-------|---------|-------|--------|
| Center Frequency | F ₀ | | 36 | | MHz |
| Bandwidth | В | | 2.5 | | MHz |
| Dispersion | Т | | 9 | | µsec |
| Delay | T ₀ | 7.96 | 8.047 | 8.16 | µsec |
| Insertion Loss | IL | | 32.1 | 33 | dB |
| Slope | S ₀ | -3.66 | -3.64 | -3.6 | µs/MHz |
| Pulse Width at -3 dB | | | 0.295 | 0.296 | µsec |
| Sidelobes for $ t - T_0 < T$ | | | -13.6 | -12.5 | dB |
| Time Spurious for $ t - T_0 > T$ | | | -58 | -50 | dB |
| Substrate Material | STQ | | | | |

Notes

- 1. Center Frequency (F_0) and Bandwidth (B) are defined, not measured. Dispersion (T) is defined as $|B^*S_0|$.
- 2. Insertion Loss is the minimum loss for $|f-F_0| < .5B$
- 3. Delay and Slope determined by best fit quadratic pulse in $|f F_0| < .5B$.
- 4. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts dF₀ = $-x * F_0$, dT₀ = $x * (T_0 + S_0 * F_0)$, dS₀ = $x * 2 * S_0$, where x = 3E-8 * (temperature 22 °C)

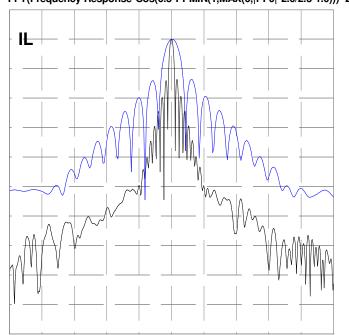
Typical Performance

Frequency Response (Best Fit Quadratic Phase Removed)



10 dB/div, 10 deg/div, 1.050 MHz/div

Compressed Pulse Response FFT(Frequency Response*Cos(0.5*PI*MIN(1,MAX(0,|f-F0|*2.0/2.5-1.0)))^2)



10 dB/div, 2.857 us/div, 0.800 us/div



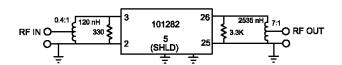
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Package Outline

2.400 Microsemi. 6Y858 1.100 101282 SERIAL NO. DATE CODE PIN 1 INDICATOR .175 MAX. .100 MIN. .100 TYP. ---⊩-- Ø.018 TYP.

Matching





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